

SP8685

500MHz÷10/11

The SP8685 is an ECL variable modulus divider, with ECL10K compatible outputs. It divides by 10 when either of the ECL control inputs, <u>PE1</u> or <u>PE2</u>, is in the high state and by 11 when both are low (or open circuit).

FEATURES

- Divides by 10 or 11
- AC-Coupled Input (Internal Bias)
- ECL Compatible Output

QUICK REFERENCE DATA

- Supply Voltage: -5·2V
- Power Consumption: 300mW
- Temperature Range:
 - -55°C to +125°C (A Grade) -30°C to +70°C (B Grade)

16 VCC NC [OUTPUT PE1 **CONTROL INPUTS** NC PE2 OUTPUT NC 13 SP8685 NC 15 12 CLOCK INPUT NC Пис 10 INTERNAL BIAS DECOUPLING NC NC 9 V_{EE} **DG16**

Fig. 1 Pin connections - top view

ABSOLUTE MAXIMUM RATINGS

Supply voltage -8VOutput current 20mAStorage temperature range $-65^{\circ}C$ to $+150^{\circ}C$ Max. junction temperature $+175^{\circ}C$ Max. clock input voltage 2.5V p-p

ORDERING INFORMATION

SP8685 A DG SP8685 B DG SP8685 AC DG SP8685 NA 1C

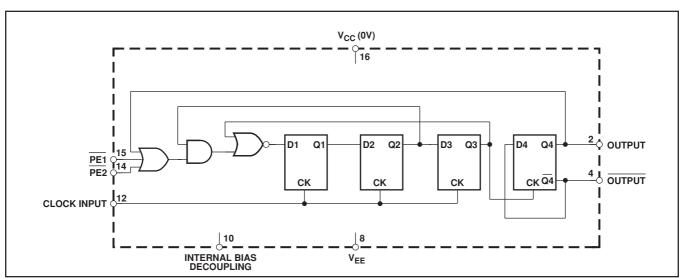


Fig. 2 Functional diagram

ELECTRICAL CHARACTERISTICS

Unless otherwise stated, the Electrical Characteristics are guaranteed over specified supply, frequency and temperature range Supply voltage, $V_{CC} = 0V$, $V_{EC} = -5.2V \pm 0.25V$

Supply voltage, V_{CC} = 0V, V_{EE} = $-5\cdot2V$ \pm 0·25V Temperature, T_{AMB} = $-55^{\circ}C$ to $+125^{\circ}C$ (A Grade), $-30^{\circ}C$ to $+70^{\circ}C$ (B Grade)

Characteristic	Symbol	Value		Units	0	Notes
		Min.	Max.	Units	Conditions	140163
Maximum frequency (sinewave input)	f _{MAX}	500		MHz	Input = 400-800mV p-p	
Minimum frequency (sinewave input)	f _{MIN}		50	MHz	Input = 400-800mV p-p	
Power supply current	I _{EE}		70	mA	$V_{EE} = -5.2V$	
Output high voltage	V _{OH}	-0.87	-0.7	V	$V_{EE} = -5.2V (25^{\circ}C)$	
Output low voltage	V _{OL}	−1·8	−1·5	V	$V_{EE} = -5.2V (25^{\circ}C)$	
PE input high voltage	V _{INH}	-0.93		V	$V_{EE} = -5.2V (25^{\circ}C)$	
PE input low voltage	V_{INL}		-1.62	V	$V_{EE} = -5.2V (25^{\circ}C)$	
Clock to output delay	tp		6	ns		5
Set-up time	ts	2		ns		5
Release time	t _r	2		ns		5

NOTES

- 1. The temperature coefficients of $V_{OH} = +1.63 \text{mV}/^{\circ}\text{C}$, $V_{OL} = +0.94 \text{mV}/^{\circ}\text{C}$ and of $V_{IN} = +1.22 \text{mV}/^{\circ}\text{C}$.
- 2. The test configuration for dynamic testing is shown in Fig.6.
- 3. The set-up time t_s is defined as the minimum time that can elapse between L→H transition of control input and the next L→H clock pulse transition to ensure that the ÷10 mode is obtained.
- The release time t_r is defined as the minimum time that can elapse between H→L transition of control input and the next L→H clock pulse transition to ensure that the ÷11 mode is obtained.
- 5. Guaranteed but not tested.

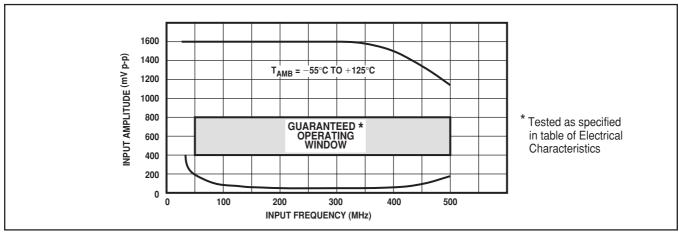


Fig. 3 Typical input characteristic of SP8685A

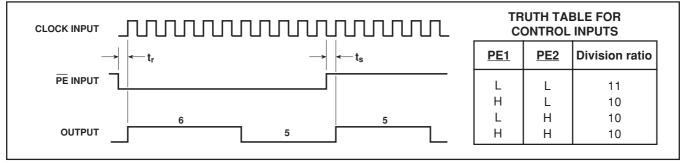


Fig. 4 Timing diagram

OPERATING NOTES

- 1. The clock input is biased internally and is coupled to the signal source with a suitable capacitor. The input signal path is completed by an input reference decoupling capacitor which is connected from pin 10 to ground.
- 2. If no signal is present the device will self-oscillate. If this is undesirable, it may be prevented by connecting a $15k\Omega$ resistor from the clock input (pin 12) to V_{EE} . This will reduce the input sensitivity by approximately 100mV.
- 3. The circuit will operate down to DC but slew rate must be better than 100V/µs.
- 4. The outputs are compatible with ECLII but can be interfaced to
- ECL10K as shown in Fig. 7. 5. The PE inputs are ECLIII/10K compatible and include $4\cdot3k\Omega$ pulldown resistors. Unused inputs can therefore be left open.
- 6. Input impedance is a function of frequency, See Fig. 5.
- 7. All components should be suitable for the frequency in use.

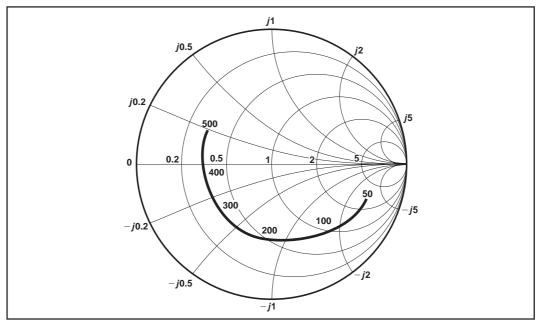


Fig. 5 Typical input impedance. Test conditions: Supply Voltage = -5.2V, Ambient Temperature = 25° C. Frequencies in MHz, impedances normalised to 50Ω .

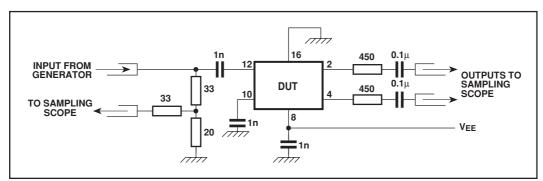


Fig. 6 Test circuit

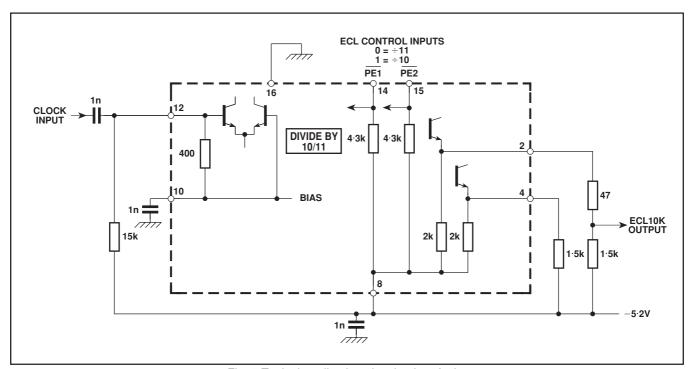
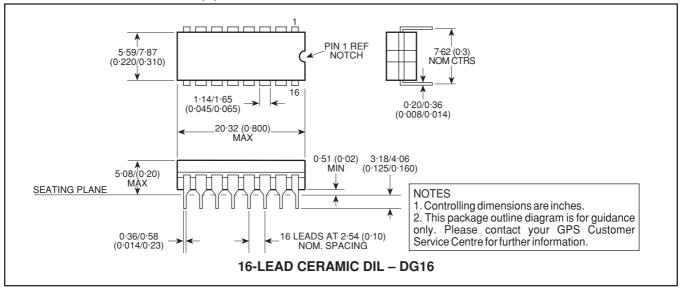


Fig. 7 Typical application showing interfacing

NOTES

PACKAGE DETAILS

Dimensions are shown thus: mm (in).





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